08-03-2000



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U.S. Department of Commerce Patent and Trademark Office

To the Honorable Commissioner of Patents and Trademarks. Please record the attached original documents or copy thereof. 1. Name of Conveying Party: 2. Name and Address of Receiving Party(ies): Name: Hyundai Electronics Industries Co., Ltd. 1.11.W Street Address: San 136-1, Ami-ri, Bubal-eub, Inchon-shi City, State, Zip: Kyoungki-do, Republic of Korea ☐ Additional name(s) and address(es) attached. ☐ Additional names of conveying parties attached. 3. Nature of Conveyance ☐ Assignment ☐ Merger ☐ Change of Name ☐ Security Agreement X Other: Corrective Assignment to correct name of assignee recorded on Reel/Frame010089/0940 Execution Date: June 1, 1999 4. (B) Patent Number(s): 4. (A) Patent Application Number(s): 09/337,010 If this document is being filed together with a new application, the execution date of the application is: ☐ Additional Numbers Attached. 6. Total Number of Applications and Patents Involved: 5. Name and Address of Party to whom Correspondence Concerning this Document Should be Mailed: 7. Total Fee: Gary M. Nath Name: **NATH & ASSOCIATES** \$ 40.00 Address: (37 CFR 3.41) 1030 15th Street, N.W. -- 6th floor Washington, D.C. 20005 X Enclosed. Authorized to be charged to deposit account. 8. Deposit Account Number: 08/02/2000 DNGUYEN 00000193 09337010 14-0112 40.00 DP ATTACH DUPLICATE COPY OF THIS PAGE IF PAYING BY DEPOSIT ACCOUN DO NOT USE THIS SPACE 9. Statement and Signature: To the best of my knowledge and belief, the foregoing is true and correct and any attached copy is a true copy of the griginal document. Name of Person Signing Attorney Docket No.: 23923 Total number of pages comprising cover sheet: 1

> **PATENT** REEL: 010957 FRAME: 0880

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| Assignment | of | U.S. | Rights | Attv. | Dkt. | No.: | 23923 |
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| | | | | | | | |

<u>ASSIGNMENT</u>

For good and valuable consideration, the sufficiency and receipt of which is hereby acknowledge, as a below named inventor, I hereby sell and assign to **Hyundai Electronics Industries Co.**, **Ltd.**

San 136-1, Ami-ri, Bubal-eub, Ichon-shi, Kyoungki-do, Korea

its successors and assigns or other legal representatives all my rights, title and interest, in and for the United States of America, in and to "A SEMICONDUCTOR MEMORY DEVICE"

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent filed as,

| Serial | No. | filed | on | |
|--------|-----|-----------|----|--|
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and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said assignee, its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

PATENT REEL: 010957 FRAME: 0881 And I hereby agree to sign and execute any further documents of instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said assignee.

The undersigned authorize and request the Commissioner of Patents to issue said Letters Patent to said assignee.

The undersigned hereby grant(s) the law firm of Nath & Associates, 1030 15th Street, NW-6th Floor, Washington, D.C. 20005, the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document.

June 1, 1999
Signature Mi Young KIM
Date

RECORDED: 07/11/2000

PATENT REEL: 010957 FRAME: 0882